



# Power MOSFETS

## DATASHEET

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**LM40014NAK8A**

N-Channel  
Enhancement Mode MOSFET

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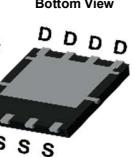
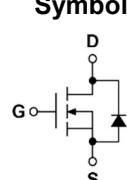
Quality Management Systems  
ISO 9001:2015 Certificate

# LM40014NAK8A

## N-Channel Enhancement Mode MOSFET

### Pin Description

### Product Summary

PDFN5*6	Symbol	Symbol	N-Channel	Unit
Top View 			$V_{DSS}$	40 V
			$R_{DS(ON)-Max}$	1.4 mΩ
			ID	252 A

### Feature

- Fast switching speed
- Reliable and Rugged
- ROHS Compliant & Halogen-Free
- 100% UIS and Rg Tested

### Applications

- Power Management in DC/DC Converters
- Server power supply
- Motor control
- Power OR-ing

### Ordering Information

Orderable Part Number	Package Type	Form	Shipping	Marking
LM40014NAK8A	PDFN5*6	Tape & Reel	5000 / Tape & Reel	40014 <input type="checkbox"/> <input type="checkbox"/> <input type="checkbox"/> <input type="checkbox"/> <input type="checkbox"/>

Note :      = Lot Code

### Absolute Maximum Ratings ( $T_J=25^\circ\text{C}$ Unless Otherwise Noted)

Symbol	Parameter		N-Channel	Unit
$V_{DSS}$	Drain-Source Voltage		40	V
$V_{GSS}$	Gate-Source Voltage		$\pm 20$	
$T_J$	Maximum Junction Temperature		150	°C
$T_{STG}$	Storage Temperature Range		-55 to 150	°C
$I_S$	Diode Continuous Forward Current	$T_c=25^\circ\text{C}$	81	A
$I_{DM}^{(1)}$	Pulse Drain Current Tested	$T_c=25^\circ\text{C}$	400	A
$I_D$	Continuous Drain Current	$T_c=25^\circ\text{C}$	252	A
		$T_c=100^\circ\text{C}$	160	
$P_D$	Maximum Power Dissipation	$T_c=25^\circ\text{C}$	89	W
		$T_c=100^\circ\text{C}$	36	
$I_D$	Continuous Drain Current	$T_A=25^\circ\text{C}$	42	A
		$T_A=70^\circ\text{C}$	34	
$P_D$	Maximum Power Dissipation	$T_A=25^\circ\text{C}$	2.5	W
		$T_A=70^\circ\text{C}$	1.6	
$I_{AS}^{(2)}$	Avalanche Current, Single pulse	L=0.1mH	54	A
		L=0.5mH	30	
$E_{AS}^{(2)}$	Avalanche Energy, Single pulse	L=0.1mH	146	mJ
		L=0.5mH	225	

### Thermal Characteristics

Symbol	Parameter		Rating	Unit
$R_{\theta JC}$	Thermal Resistance-Junction to Case	Steady State	1.4	°C/W
$R_{\theta JA}^{(3)}$	Thermal Resistance-Junction to Ambient	Steady State	50	°C/W

Note ① : Max. current is limited by bonding limit

Note ② : UIS tested and pulse width are limited by maximum junction temperature 150°C

Note ③ : Surface Mounted on 1in<sup>2</sup> FR-4 board with 1oz

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## N-Channel Electrical Characteristics ( $T_J=25^\circ\text{C}$ Unless Otherwise Noted)

Symbol	Parameter	Test Conditions	Min.	Typ.	Max.	Unit
<b>Static Electrical Characteristics</b>						
<b><math>\text{BV}_{\text{DSS}}</math></b>	Drain-Source Breakdown Voltage	$V_{\text{GS}}=0\text{V}, I_{\text{DS}}=250\mu\text{A}$	40	-	-	V
<b><math>I_{\text{DSS}}</math></b>	Zero Gate Voltage Drain Current	$V_{\text{DS}}=32\text{V}, V_{\text{GS}}=0\text{V}$	-	-	1	$\mu\text{A}$
<b><math>V_{\text{GS(th)}}</math></b>	Gate Threshold Voltage	$V_{\text{DS}}=V_{\text{GS}}, I_{\text{DS}}=250\mu\text{A}$	1.1	1.6	2.1	V
<b><math>I_{\text{GSS}}</math></b>	Gate Leakage Current	$V_{\text{GS}}=\pm 20\text{V}, V_{\text{DS}}=0\text{V}$	-	-	$\pm 100$	$\text{nA}$
<b><math>R_{\text{DS(ON)}}^{\circledast}</math></b>	Drain-Source On-state Resistance	$V_{\text{GS}}=10\text{V}, I_{\text{DS}}=25\text{A}$	-	1.2	1.4	$\text{m}\Omega$
		$V_{\text{GS}}=4.5\text{V}, I_{\text{DS}}=25\text{A}$		1.7	2.2	
<b><math>g_{\text{fs}}</math></b>	Forward Transconductance	$V_{\text{DS}}=2.5\text{V}, I_{\text{DS}}=20\text{A}$	-	67	-	S
<b>Dynamic Characteristics <sup>®</sup></b>						
<b><math>R_{\text{G}}</math></b>	Gate Resistance	$V_{\text{GS}}=0\text{V}, V_{\text{DS}}=0\text{V},$ $\text{Freq.}=1\text{MHz}$	-	5.4	-	$\Omega$
<b><math>C_{\text{iss}}</math></b>	Input Capacitance	$V_{\text{GS}}=0\text{V},$ $V_{\text{DS}}=20\text{V},$ $\text{Freq.}=1\text{MHz}$	-	4112	-	$\text{pF}$
<b><math>C_{\text{oss}}</math></b>	Output Capacitance		-	1367	-	
<b><math>C_{\text{rss}}</math></b>	Reverse Transfer Capacitance		-	53	-	
<b><math>t_{\text{d(ON)}}</math></b>	Turn-on Delay Time	$V_{\text{GS}}=10\text{V}, V_{\text{DS}}=20\text{V},$ $I_{\text{D}}=25\text{A}, R_{\text{GEN}}=6\Omega$	-	12.7	-	$\text{nS}$
<b><math>t_{\text{r}}</math></b>	Turn-on Rise Time		-	96.1	-	
<b><math>t_{\text{d(OFF)}}</math></b>	Turn-off Delay Time		-	97.2	-	
<b><math>t_{\text{f}}</math></b>	Turn-off Fall Time		-	94	-	
<b><math>Q_{\text{g}}</math></b>	Total Gate Charge	$V_{\text{GS}}=4.5\text{V}, V_{\text{DS}}=20\text{V}$ $I_{\text{D}}=55\text{A}$	-	29.3	-	$\text{nC}$
<b><math>Q_{\text{g}}</math></b>	Total Gate Charge	$V_{\text{GS}}=10\text{V}, V_{\text{DS}}=20\text{V},$ $I_{\text{D}}=55\text{A}$	-	60.4	-	
<b><math>Q_{\text{gs}}</math></b>	Gate-Source Charge		-	13.5	-	
<b><math>Q_{\text{gd}}</math></b>	Gate-Drain Charge		-	9.3	-	
<b>Source-Drain Characteristics</b>						
<b><math>V_{\text{SD}}^{\circledast}</math></b>	Diode Forward Voltage	$I_{\text{SD}}=50\text{A}, V_{\text{GS}}=0\text{V}$	-	0.8	1.1	V
<b><math>t_{\text{rr}}</math></b>	Reverse Recovery Time	$I_{\text{F}}=50\text{A}, V_{\text{R}}=0\text{V}$	-	48.5	-	nS
<b><math>Q_{\text{rr}}</math></b>	Reverse Recovery Charge	$dI_{\text{F}}/dt=100\text{A}/\mu\text{s}$	-	40.5	-	nC

Note ④ : Pulse test (pulse width $\leq 300\mu\text{s}$ , duty cycle $\leq 2\%$ ).

Note ⑤ : Guaranteed by design, not subject to production testing.

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## N-Channel Typical Characteristics

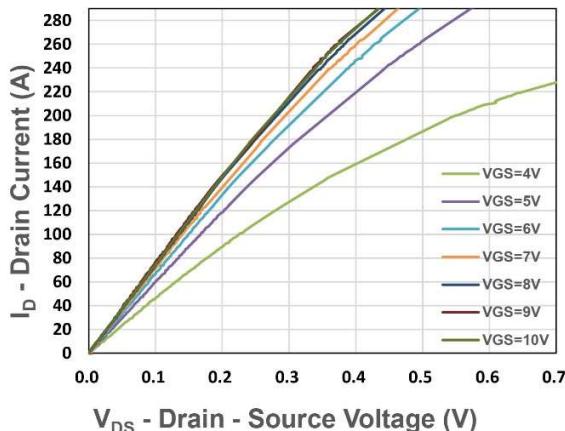


Figure 1. Output Characteristics

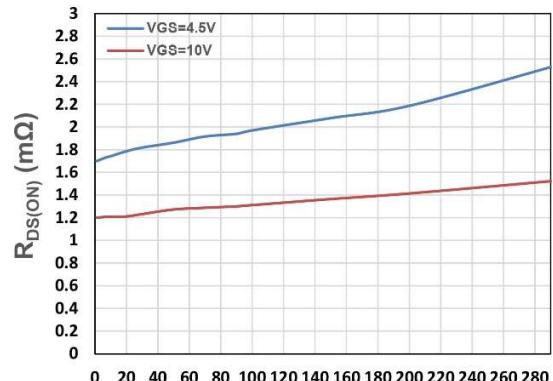


Figure 2. On-Resistance vs. ID

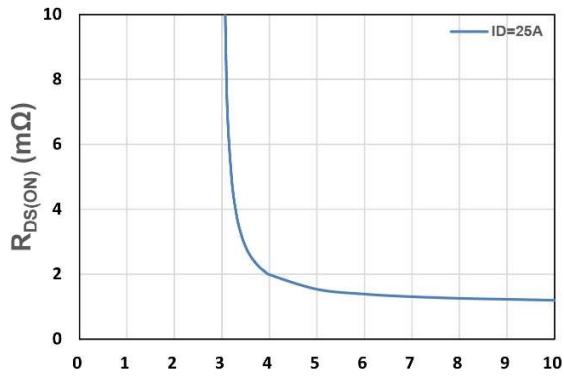


Figure 3. On-Resistance vs. VGS

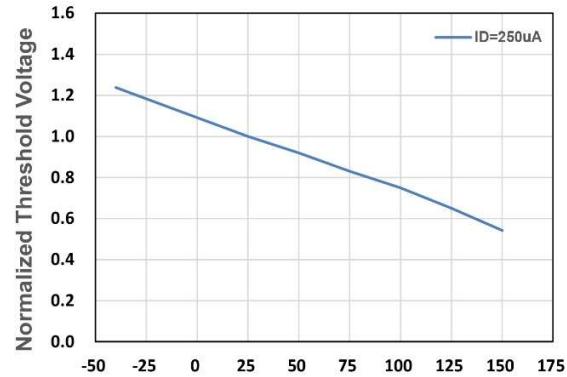


Figure 4. Gate Threshold Voltage

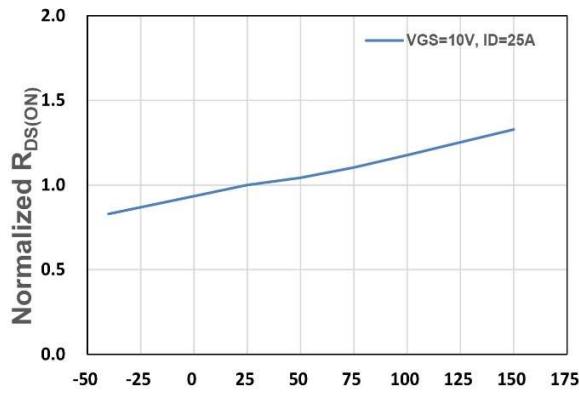


Figure 5. Drain-Source On Resistance

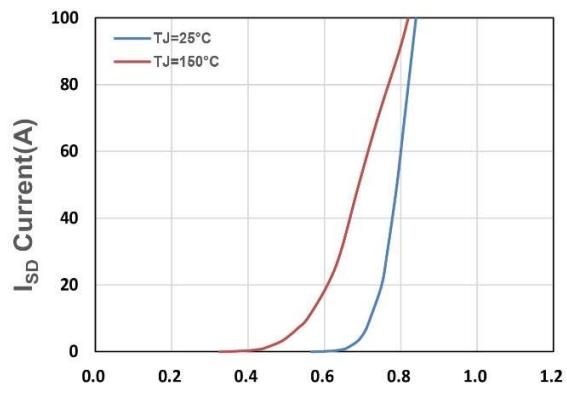
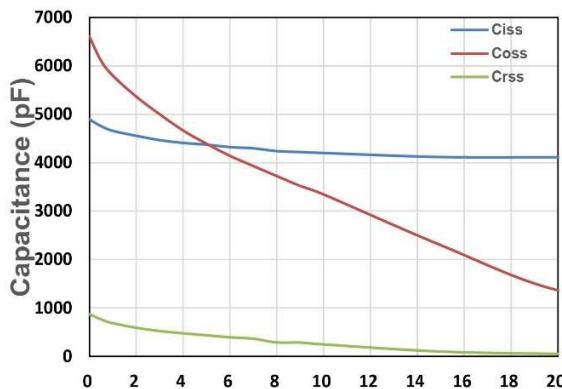
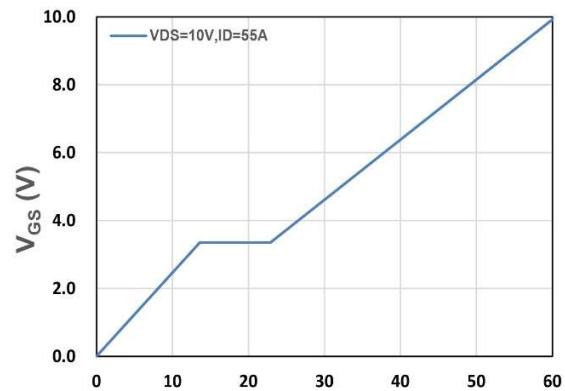


Figure 6. Source-Drain Diode Forward

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$V_{DS}$  - Drain - Source Voltage (V)  
Figure 7. Capacitance



$Q_g$ , Total Gate Charge (nC)  
Figure 8. Gate Charge Characteristics

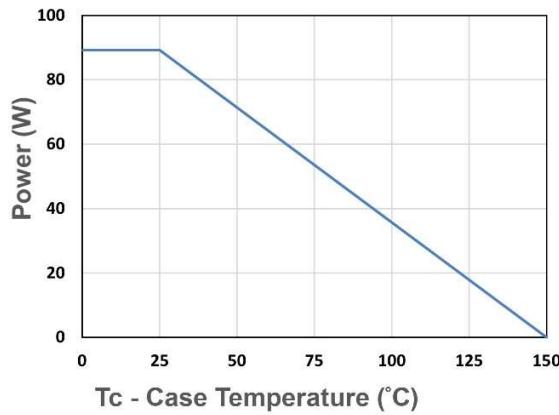


Figure 9. Power Dissipation

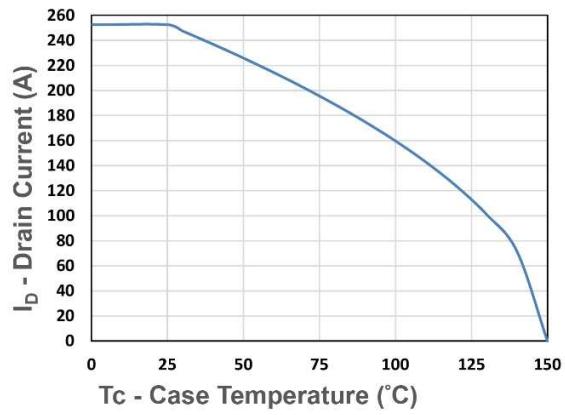
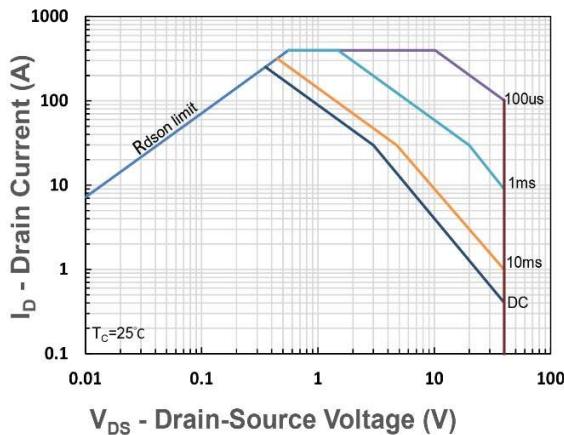


Figure 10. Drain Current



$V_{DS}$  - Drain-Source Voltage (V)  
Figure 11. Safe Operating Area

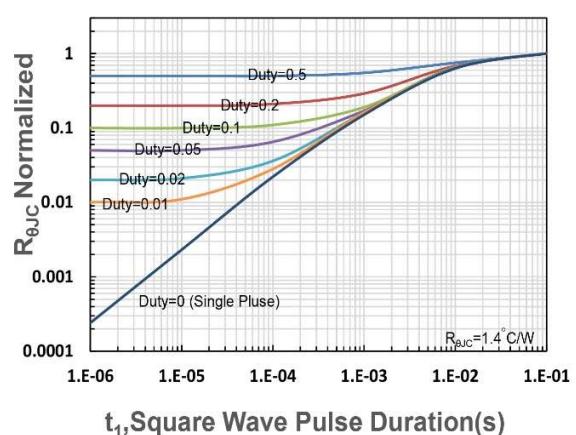


Figure 12.  $R_{θJC}$  Transient Thermal Impedance